

FDG332PZ

P-Channel PowerTrench[®] MOSFET

-**20V, -2.6A, 97m**Ω

Features

- Max $r_{DS(on)}$ = 95m Ω at V_{GS} = -4.5V, I_D = -2.6A
- Max $r_{DS(on)}$ = 115m Ω at V_{GS} = -2.5V, I_D = -2.2A
- Max $r_{DS(on)}$ = 160m Ω at V_{GS} = -1.8V, I_D = -1.9A
- Max $r_{DS(on)}$ = 330m Ω at V_{GS} = -1.5V, I_D = -1.0A
- Very low level gate drive requirements allowing operation in 1.5V circuits
- Very small package outline SC70-6
- RoHS Compliant

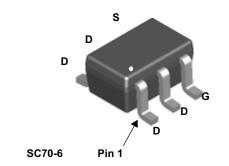


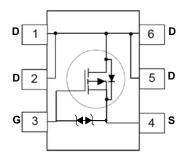
General Description

This P-Channel MOSFET uses Fairchild's advanced low voltage PowerTrench[®] process. It has been optimized for battery power management applications.

Applications

- Battery management
- Load switch





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V
V _{GS}	Gate to Source Voltage		±8	V
1	Drain Current -Continuous		-2.6	•
D	-Pulsed		-9	— A
D	Power Dissipation	(Note 1a)	0.75	10/
PD	Power Dissipation	(Note 1b)	0.48	- W
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

R _{0JA}	Thermal Resistance, Junction to Ambient Single operation	(Note 1a)	170	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient Single operation	(Note 1b)	260	0.00

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.2P	FDG332PZ	SC70-6	7"	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		-13		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16V, V _{GS} = 0V			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8V, V_{DS} = 0V$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.7	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		2.5		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = -4.5V, I _D = -2.6A		73	95	mΩ
		V_{GS} = -2.5V, I_{D} = -2.2A		90	115	
		V _{GS} = -1.8V, I _D = -1.9A		117	160	
		V _{GS} = -1.5V, I _D = -1.0A		147	330	
		V_{GS} = -4.5V, I_D = -2.6A , T_J = 125°C		100	133	
9fs	Forward Transconductance	$V_{DD} = -5V, I_D = -2.6A$		9		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			420	560	pF
C _{oss}	Output Capacitance	V _{DS} = -10V, V _{GS} = 0V, f = 1MHZ		85	115	pF
C _{rss}	Reverse Transfer Capacitance			75	115	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			5.2	10	ns
t _r	Rise Time	V _{DD} = -10V, I _D = -2.6A,		4.8	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$		59	95	ns
t _f	Fall Time			28	45	ns
Qg	Total Gate Charge			7.6	10.8	nC
Q _{gs}	Gate to Source Charge	V _{GS} = -4.5V, V _{DD} = -10V, I _D = -2.6A		0.9		nC
Q _{gd}	Gate to Drain "Miller" Charge			1.9		nC

Drain-Source Diode Characteristics and Maximum Ratings

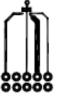
I _S	Maximum Continuous Drain-Source Diode Forward Current			-0.6	A
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = -0.6A (Note 2)	-0.7	-1.2	V
t _{rr}	Reverse Recovery Time	I _F = 2.6A, di/dt = 100A/μs	28	45	ns
Q _{rr}	Reverse Recovery Charge	$-1F - 2.0A, u/ut - 100A/\mu S$	8	13	nC

Notes: 1. R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 170°C/W when mounted on a 1 in² pad of 2 oz copper .

b. 260°C/W when mounted on

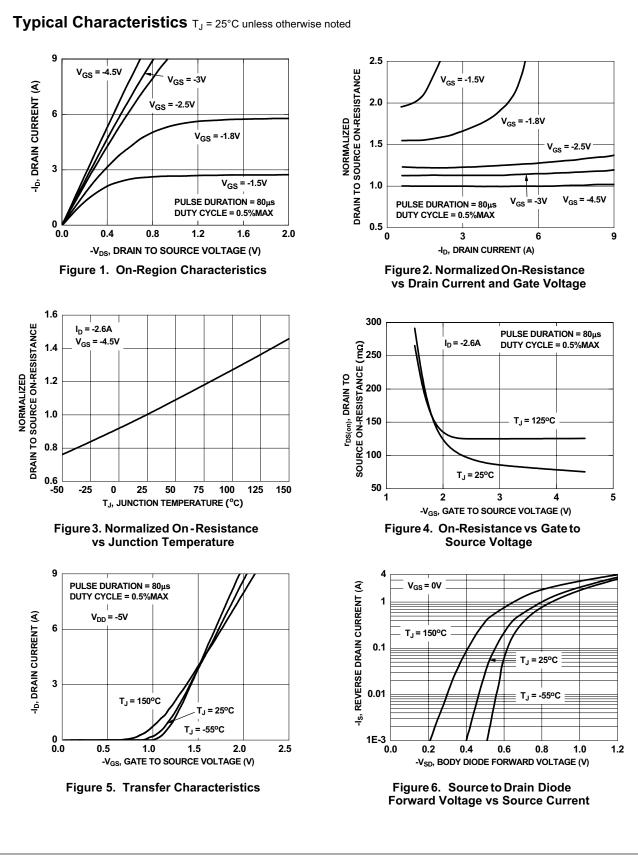


a minimum pad of 2 oz copper.



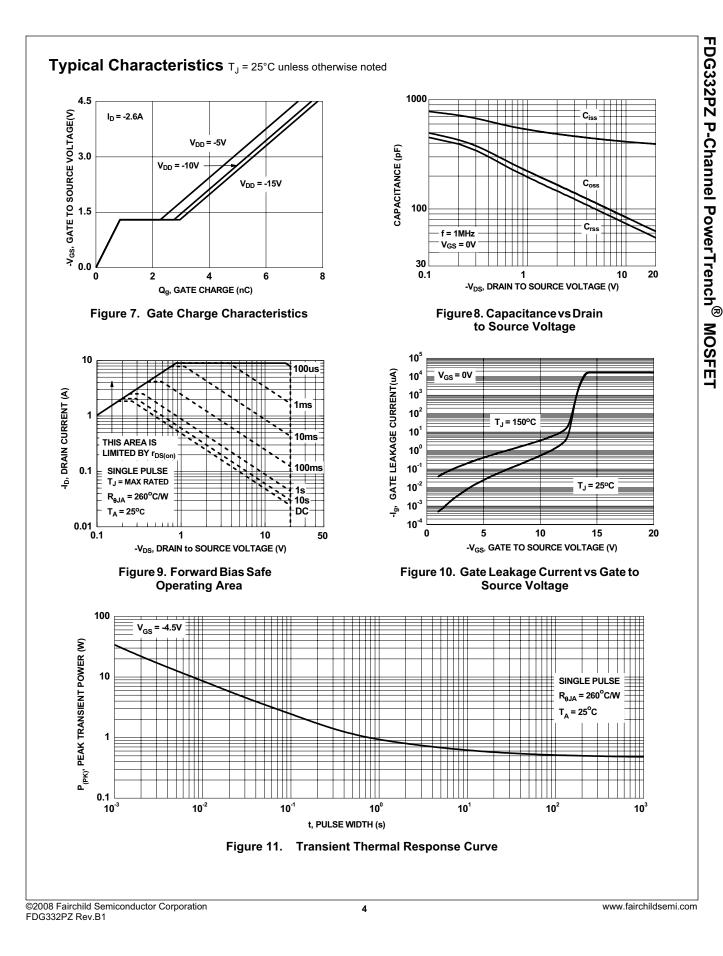
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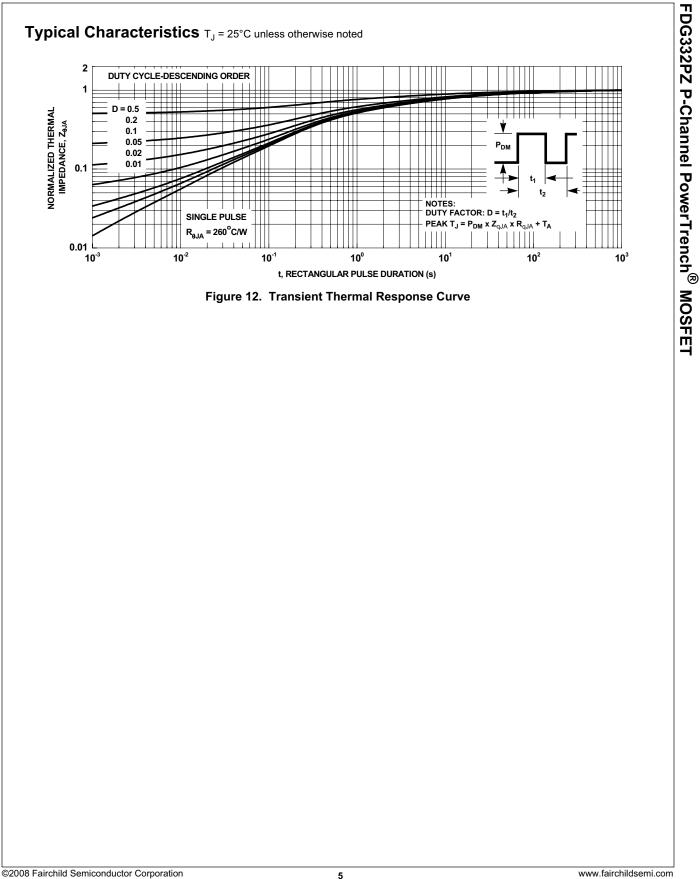
2. Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.



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